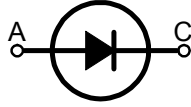


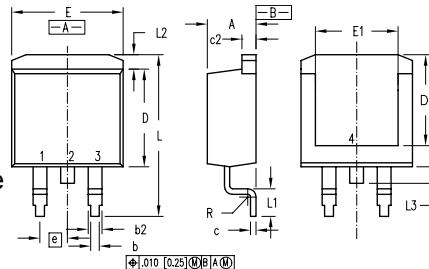
SUR860S

Soft Recovery Behaviour Ultra Fast Recovery Epitaxial Diodes

C(TAB)



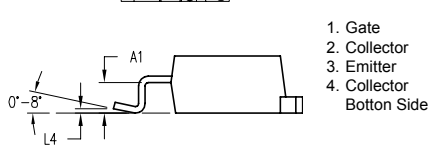
Dimensions TO-263(D²PAK)



| Dim. | Millimeter | | Inches | |
|------|------------|-------|----------|------|
| | Min. | Max. | Min. | Max. |
| A | 4.06 | 4.83 | .160 | .190 |
| A1 | 2.03 | 2.79 | .080 | .110 |
| b | 0.51 | 0.99 | .020 | .039 |
| b2 | 1.14 | 1.40 | .045 | .055 |
| c | 0.46 | 0.74 | .018 | .029 |
| c2 | 1.14 | 1.40 | .045 | .055 |
| D | 8.64 | 9.65 | .340 | .380 |
| D1 | 8.00 | 8.89 | .315 | .350 |
| E | 9.65 | 10.29 | .380 | .405 |
| E1 | 6.22 | 8.13 | .245 | .320 |
| e | 2.54 BSC | | .100 BSC | |
| L | 14.61 | 15.88 | .575 | .625 |
| L1 | 2.29 | 2.79 | .090 | .110 |
| L2 | 1.02 | 1.40 | .040 | .055 |
| L3 | 1.27 | 1.78 | .050 | .070 |
| L4 | 0 | 0.20 | 0 | .008 |
| R | 0.46 | 0.74 | .018 | .029 |

A=Anode, NC= No connection, TAB=Cathode

| | V _{RSM} | V _{RRM} |
|----------------|------------------|------------------|
| | V | V |
| SUR860S | 600 | 600 |



1. Gate
2. Collector
3. Emitter
4. Collector Bottom Side

| Symbol | Test Conditions | Maximum Ratings | Unit |
|---|--|---|------------------|
| I_{FRMS} | T _{VJ} =T _{VJM} | 16 | A |
| I_{FAVM} | T _C =115°C; rectangular, d=0.5 | 8 | |
| I_{FRM} | t _p <10us; rep. rating, pulse width limited by T _{VJM} | 130 | |
| I_{FSM} | T _{VJ} =45°C | t=10ms (50Hz), sine t=8.3ms (60Hz), sine | A |
| | T _{VJ} =150°C | t=10ms(50Hz), sine t=8.3ms(60Hz), sine | |
| I²t | T _{VJ} =45°C | t=10ms (50Hz), sine t=8.3ms (60Hz), sine | A ² s |
| | T _{VJ} =150°C | t=10ms(50Hz), sine t=8.3ms(60Hz), sine | |
| T_{VJ} T_{VJM} T_{stg} | | -40...+150 150 -40...+150 | °C |
| P_{tot} | T _C =25°C | 50 | W |
| M_d | Mounting torque | 0.4...0.6 | Nm |
| Weight | | 2 | g |

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Soft Recovery Behaviour Ultra Fast Recovery Epitaxial Diodes

| Symbol | Test Conditions | Characteristic Values | | Unit |
|---|--|-----------------------|------|------|
| | | typ. | max. | |
| I_R | $T_{VJ}=25^{\circ}\text{C}; V_R=V_{RRM}$ | | 20 | uA |
| | $T_{VJ}=25^{\circ}\text{C}; V_R=0.8 \cdot V_{RRM}$ | | 10 | uA |
| | $T_{VJ}=125^{\circ}\text{C}; V_R=0.8 \cdot V_{RRM}$ | | 1.5 | mA |
| V_F | $I_F=8\text{A}; T_{VJ}=150^{\circ}\text{C}$ | | 1.3 | V |
| | $T_{VJ}=25^{\circ}\text{C}$ | | 1.5 | |
| V_{TO} | For power-loss calculations only | | 0.98 | V |
| r_T | $T_{VJ}=T_{VJM}$ | | 28.7 | mΩ |
| R_{thJC} R_{thCK} R_{thJA} | | 0.5 | 2.5 | K/W |
| | | | 60 | |
| | | | | |
| t_{rr} | $I_F=1\text{A}; -di/dt=50\text{A/us}; V_R=30\text{V}; T_{VJ}=25^{\circ}\text{C}$ | 35 | 50 | ns |
| I_{RM} | $V_R=540\text{V}; I_F=15\text{A}; -di_F/dt=100\text{A/us}; L \leq 0.05\mu\text{H}; T_{VJ}=100^{\circ}\text{C}$ | 2.5 | 2.8 | A |

FEATURES

- * International standard package JEDEC TO-220AC
- * Glass passivated chips
- * Very short recovery time
- * Extremely low switching losses
- * Low I_{RM}-values
- * Soft recovery behaviour
- * RoHS compliant

APPLICATIONS

- * Antiparallel diode for high frequency switching devices
- * Antisaturation diode
- * Snubber diode
- * Free wheeling diode in converters and motor control circuits
- * Rectifiers in switch mode power supplies (SMPS)
- * Inductive heating and melting
- * Uninterruptible power supplies (UPS)
- * Ultrasonic cleaners and welders

ADVANTAGES

- * High reliability circuit operation
- * Low voltage peaks for reduced protection circuits
- * Low noise switching
- * Low losses
- * Operating at lower temperature or space saving by reduced cooling



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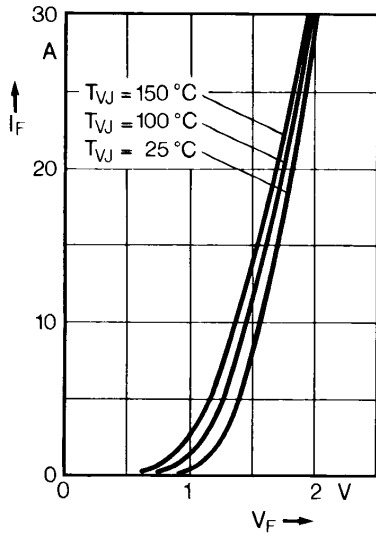


Fig. 1 Forward current versus voltage drop.

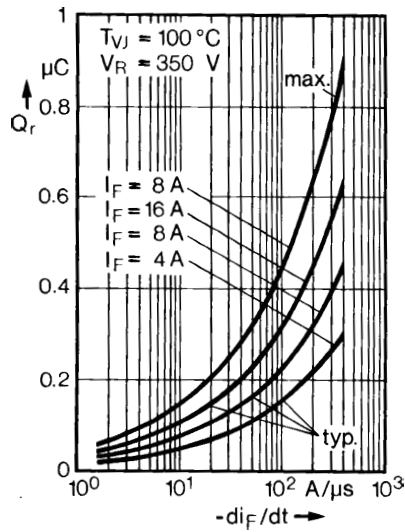


Fig. 2 Recovery charge versus $-di_F/dt$.

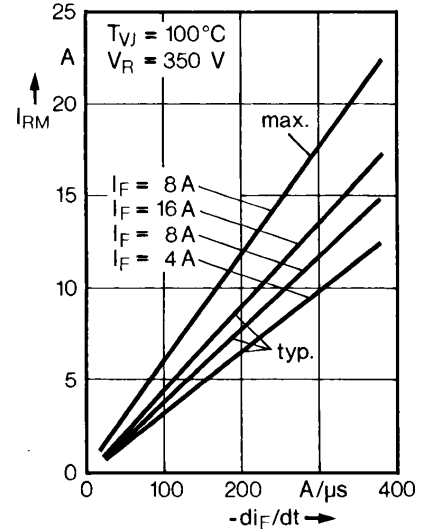


Fig. 3 Peak reverse current versus $-di_F/dt$.

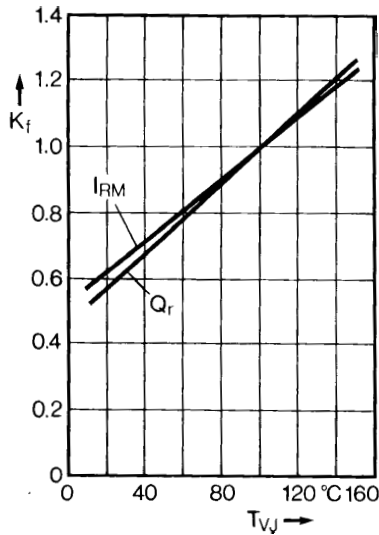


Fig. 4 Dynamic parameters versus junction temperature.

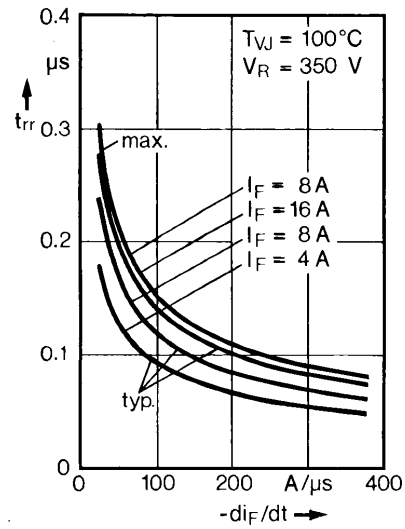


Fig. 5 Recovery time versus $-di_F/dt$.

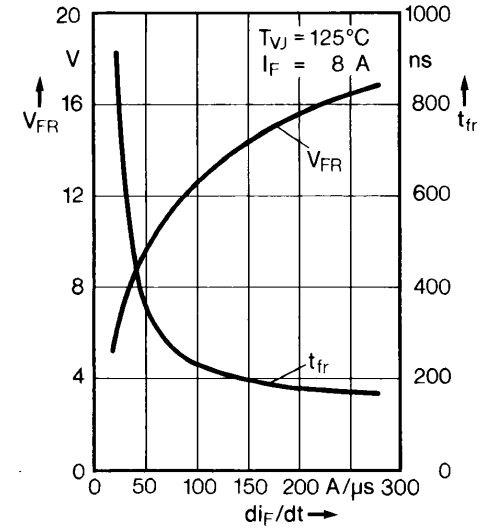


Fig. 6 Peak forward voltage versus di_F/dt .

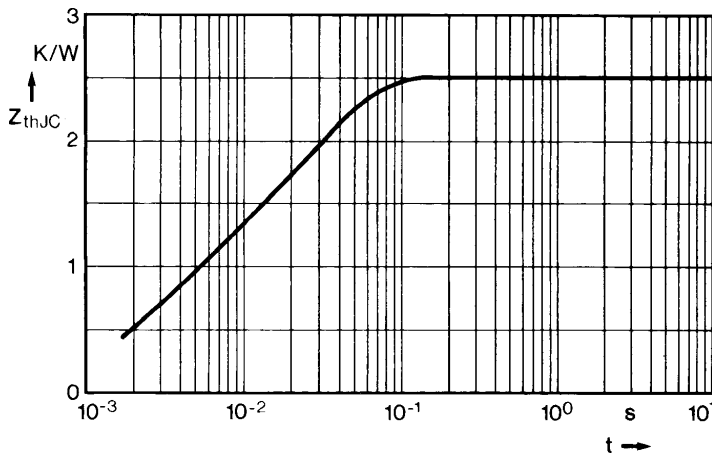


Fig. 7 Transient thermal impedance junction to case.

